PCN Number:		20220418000.2						PCN Date: April 19, 2022			
Title: Qualification of TI Philippines as an additional Test Site for select devices									5		
Customer Contact:		PCN Manager		Dept:	Quality Serv						
Proposed 1 st Ship Date:		Oct 19, 2		Estimated Sam Availabi							
Change											
Assembly Site				Design				Wafer Bump Site			
Assembly Process				Data Sheet			Ц		afer Bump Material		
Assembly Materials				Part number		ange 🗌			Wafer Bump Process		
Mechanical Specific				Test Site				Wafer Fab Site Wafer Fab Materials			
Packing/Shipping/L				Test Plue	Test Process			Wafer Fab Process			
PCN Details											
Description of Change:											
Texas Instruments Incorporated is announcing the qualification of TI Philippines as Additional Test Site for select devices listed in the "Product Affected" Section.											
		Current				New					
Te	Test Site		LEN			TI Philippines					
Test solutions remain unchanged. Tester platform, test coverage, hardware, insertions, conditions will remain consistent with current testing and verified with test MQ.											
Reason for Change:											
Enable a	lditional Test si	te capacity	to s	upport hig	h volu	me ramps.					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):											
None											
Impact on Environmental Ratings:											
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.											
	RoHS		EAC		l	een Status	5			52474	
🛛 No	Change	🛛 No Ch	ange	9	🛛 No	Change			No Cha	nge	
Changes to product identification resulting from this PCN:											
None											
Product Affected:											
TPS61040QDBVRQ1 TPS61041QDBVRQ1											

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail						
WW PCN Team	PCN_ww_admin_team@list.ti.com						

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